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SC0853AM
09/736,462

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re Application of: Tan et al.
Serial No.: 09/736,462
Filing Date: December 15, 2000
Group Art Unit: 2831
Examiner: Ngo, Hung V
Title: BUMP CHIP LEAD FRAME AND PACKAGE

I HEREBY CERTIFY THAT THIS CORRESPONDENCE IS BEING FACSIMILE
TRANSMITTED TO THE PATENT AND TRADEMARK OFFICE, ATTN EXAMINER
Ngo, Hung V, AT THE FAX NO. (703) 872-9318

ON:

January 5, 2004
Date of Facsimile Transmission

Lydia McNamara

Name of Person Signing Certificate

Lydia McNamara

SIGNATURE

1/5/04

DATE

9 pages

Commissioner for Patents,
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

SIR:

In response to the office action mailed October 3, 2003,
please amend the above-identified application as follows.